Analytical Modeling of Forced Convection in Slotted Plate Fin Heat Sinks

P. Teertstra, J. R. Culham & M. M. Yovanovich

Microelectronics Heat Transfer Laboratory Department of Mechanical Engineering University of Waterloo Waterloo, Ontario, Canada

http://www.mhtl.uwaterloo.ca

Future Challenges in Electronic Packaging International ME'99 Congress and Exposition Nashville, TN November 17, 1999

Introduction: Plate Fin Heat Sinks

- Heat transfer enhancement for air cooled applications:
 - increase effective surface area
 - decrease thermal resistance
 - control operating temperatures
- Plate fin heat sinks:

1

- most common configuration
- convection in channels between fins





Introduction: Slotted Fin Heat Sinks

- Enhanced thermal performance:
 - new thermal boundary layers initiated at each fin section
 - increase in average heat transfer coefficient
 - decrease in surface area
- Performance of slotted fin heat sinks function of slot size and spacing
- Optimal slotted fin heat sink design balances enhancement of *h* with reduction of *A*



Introduction: Heat Sink Selection

- Heat sink selection depends on many factors:
 - performance
 - dimensional constraints
 - available airflow
 - cost
- Quick and accurate design tools are required:
 - predict performance early in design
 - perform parametric studies
 - alternative to numerical simulations, experiments



Objectives

- Develop analytical models for average heat transfer rate for slotted fin heat sinks:
 - laminar, forced convection flow
 - full range of developing and fully-developed flow
 - non-isothermal fins
- Perform experimental measurements to validate proposed models:
 - range of slot sizes and spacing
 - inline and staggered slot arrangement



Problem Definition: Slotted Heat Sinks

- Uniformly sized and spaced slots in fins
 - fins slotted from tip to baseplate
 - fin sections connected only by baseplate
- Slot size and spacing described by dimensionless parameters:
 - pitch, P/L (0 < $P/L \le 1$)
 - width, S/P ($0 \le S/P < 1$)
- Slot arrangement:
 - inline
 - staggered

Microelectronics Heat Transfer Laboratory University of Waterloo

S



H

Problem Definition: Plate Fin Heat Sink

- Array of *N* plates on a single, flat baseplate
- Baseplate assumptions:
 - fins in perfect thermal contact
 - isothermal
 - adiabatic lower surface, edges
- Uniform velocity in all channels with no bypass:
 - shrouded heat sink



- with flow bypass model for un-shrouded heat sinks
- Heat sink modeled as N-1 parallel plate channels



Problem Definition: Parallel Plate Channel



- Assume b << H
 - 2D channel flow
 - neglect baseplate, shroud effects
- Isothermal boundary conditions
- Reynolds number: Re_b = $\frac{U b}{v}$
- Nusselt number:

$$\operatorname{Nu}_{b} = \frac{Q b}{k A (T_{s} - T_{a})}, \quad A = 2 L H$$



Parallel Plate Channel Model

- Composite solution of 2 limiting cases (Teertstra et al, 1999)
 - Developing Flow – Fully Developed Flow $\operatorname{Nu}_{b_{fd}} = \frac{\operatorname{Re}_{b}^{*}\operatorname{Pr}}{2}$ Composite Solution \tilde{N}^{4} 10° $\int_{\mathbf{F}_{u}|\mathbf{W}^{-}\mathbf{D}\mathbf{e}^{v\mathbf{e}|\mathbf{O}^{\mathbf{P}^{*}}} N\mathbf{u}_{i} = \left(N\mathbf{u}_{b_{fd}}^{-n} + N\mathbf{u}_{b_{dev}}^{-n} \right)^{-1/n}$ $\operatorname{Re}_{b}^{*} = \operatorname{Re}_{b} \cdot \frac{b}{L} = \frac{U b^{2}}{V L}$ 10¹_____ 10^1_* Re_b 1**0**² Developing Flow $Nu_{b_{dev}} = 0.664 \sqrt{Re_b^*} Pr^{1/3} \left(1 + \frac{3.65}{\sqrt{Re_r^*}} \right)^{1/2}$



Plate Fin Heat Sink Model

- Fin effects included in heat sink model:
 - high aspect ratio heat sinks for power electronics
 - dense arrays of tall, thin fins
 - increased surface area for convection
 - efficiency reduced
- Fin efficiency: $\eta = Nu_b / Nu_i$
- Assume adiabatic condition at fin tip:

$$\eta = \frac{\tanh(mH)}{mH}, \quad m = \sqrt{\frac{hP}{kA_c}}, \quad h = \operatorname{Nu}_i \cdot \frac{k_f}{b}$$

Microelectronics Heat Transfer Laboratory University of Waterloo



P = 2 t + 2 L

 $A_c = t L$

H

9

Plate Fin Heat Sink Model

• Model Summary

$$Q = N \cdot \frac{k_f A (T_s - T_a)}{b} \cdot \eta \cdot \operatorname{Nu}_i$$

$$\operatorname{Nu}_i = \left[\left(\frac{\operatorname{Re}_b^* \operatorname{Pr}}{2} \right)^{-3} + \left(0.664 \sqrt{\operatorname{Re}_b^*} \operatorname{Pr} \left(1 + \frac{3.65}{\sqrt{\operatorname{Re}_b^*}} \right)^{1/2} \right)^{-3} \right]^{-1/3}$$

$$\eta = \frac{\tanh \sqrt{2 \operatorname{Nu}_i \frac{k_f}{k} \frac{H}{b} \frac{H}{t} \left(\frac{t}{L} + 1 \right)}}{\sqrt{2 \operatorname{Nu}_i \frac{k_f}{k} \frac{H}{b} \frac{H}{t} \left(\frac{t}{L} + 1 \right)}}$$



Slotted Fin Heat Sink - Model Bounds

- Complex problem where exact solution not possible
- Upper and lower bounds from plate fin heat sink model:





Slotted Fin Heat Sink - Lower Bound

- No new boundary layers formed
- Modeled using equivalent fin length:

$$L_{LB} = L - N_S \cdot S = L(1 - S/P)$$

• Lower bound expressions:

$$\operatorname{Re}_{LB}^{*} = \frac{\operatorname{Re}_{b}^{*}}{1 - S/P} \longrightarrow \operatorname{Nu}_{i}$$
$$\frac{t}{L_{LB}} = \frac{t/L}{1 - S/P} \longrightarrow \eta$$





Slotted Fin Heat Sink - Upper Bound

- New thermal boundary layer formed at each fin section with no upstream effects
- Modeled using equivalent fin length:

 $L_{UB} = P - S = L(P/L)(1 - S/P)$

• Upper bound expressions:

$$\operatorname{Re}_{UB}^{*} = \frac{\operatorname{Re}_{b}^{*}}{(P/L)(1 - S/P)} \longrightarrow \operatorname{Nu}_{i}$$
$$\frac{t}{L_{UB}} = \frac{t/L}{(P/L)(1 - S/P)} \longrightarrow \eta$$





Experimental Apparatus

- High aspect ratio, $H/b \approx 20$
- Various slot configurations
- Back-to-back arrangement
- Mounted in Plexiglas shroud
- Approach velocity measured with hot wire anemometer

P/L	S/P	Slots
0.059	0.54	inline
0.11	0.5	inline
0.22	0.5	inline
0.44	0.5	inline
0.22	0.5	staggered
0.44	0.5	staggered

- Temperatures measured at 4 locations on baseplate
- Radiation losses measured in separate experiment



Experimental Results



Microelectronics Heat Transfer Laboratory University of Waterloo



Model Validation



Microelectronics Heat Transfer Laboratory University of Waterloo



16

Model Validation



• Arithmetic mean of bounds within 12% RMS of data

$$Nu_{b} = \frac{Nu_{LB} + Nu_{UB}}{2} \qquad 40 \le Re_{b}^{*} \le 180$$
$$0.11 \le P/L \le 0.44$$
$$S/P = 0.5$$



Summary and Conclusions

- Models developed for upper and lower bounds for slotted fin heat sinks
- Experimental data within bounds for full range of test conditions
- Arithmetic mean of bounds predicts Nu_b within 12% RMS over range of test conditions
- Reliable optimization procedure cannot be determined from the limited range of *S*/*P* values
- Additional study and data are required





Acknowledgements

The authors gratefully acknowledge the continued financial support of R-Theta Inc. and Materials and Manufacturing Ontario.

